



Product Change Notification

Change Notification #: 118459-00
Change Title: Select 1U PCIe x16 1-slot Riser Card F1UL16RISER3, PCN 118459-00, Product Design, Product Marking
Date of Publication: August 30, 2021

Key Characteristics of the Change:

Product Design, Product Marking

Forecasted Key Milestones:

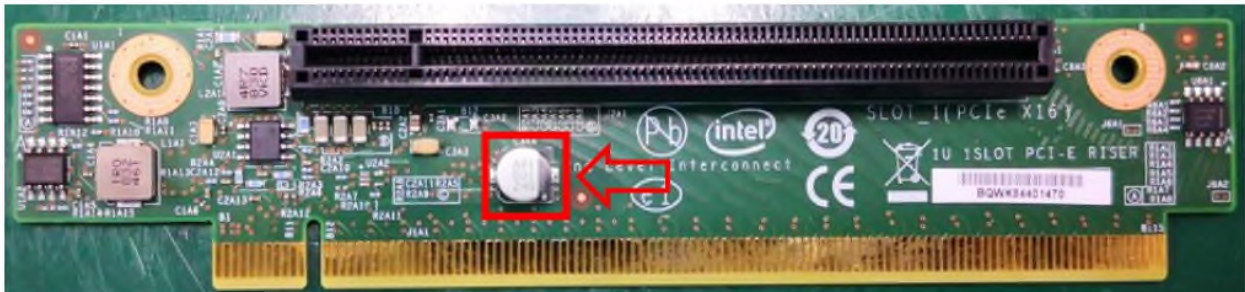
Date Customer Must be Ready to Receive Post-Conversion Material:	September 14, 2021
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the 1U PCIe x16 1-slot Riser Card F1UL16RISER3.

- Intel is adding a second source capacitor component of the item listed in table products affected table and image below.



Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Please contact your local Intel Field Sales Rep if you have any further questions about these changes

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#
1U PCIe x16 1-slot Riser Card F1UL16RISER3, Single	F1UL16RISER3	958249

PCN Revision History:**Date of Revision:**

August 30, 2021

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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